

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
EDWIN YEE MAN KEH	02/04/2021
LEI YAO	02/08/2021
HOK CHUNG CHAN	02/04/2021
SAI LUNG FUNG	02/08/2021
UN TENG LAM	02/08/2021
LAP HUNG CHAN	02/08/2021
LEE YING YU	02/04/2021
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City:	HONG KONG
State/Country:	CHINA
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17249212
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SIGNATURE:	/Danielle Y. Sneed/
DATE SIGNED:	02/24/2021

Total Attachments: 2

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Assignment by Inventors

THIS ASSIGNMENT, made by Edwin Yee Man KEH; Lei YAO; Hok Chung CHAN; Sai Lung FUNG; Un Teng LAM; Lap Hung CHAN and Lee Ying YU (hereinafter referred to as Assignors); all residing at The Hong Kong Research Institute of Textiles and Apparel Limited, Hung Hom, Kowloon, Hong Kong, CHINA.

WHEREAS, Assignors have invented certain new and useful improvements in the patent application entitled Method for Decolorizing Textiles, set forth in a Patent application for Letters Patent of the United States, filed herewith;

WHEREAS, The Hong Kong Research Institute of Textiles and Apparel Limited, a Limited Liability Company organized under and pursuant to the laws of Hong Kong, China having its principal place of business at Hung Hom, Kowloon, Hong Kong, CHINA (hereinafter referred to as Assignee), is desirous of acquiring the entire right, title and interest in and to said inventions and said Application for Letters Patent of the United States, and in and to any Letters Patent of the United States to be obtained therefore and thereon.

NOW, THEREFORE, for good and sufficient consideration, the receipt of which is hereby acknowledged, Assignors have sold, assigned, transferred and set over, and by these presents do sell, assign, transfer and set over, unto Assignee, its successors, legal representatives and assigns, the entire right, title and interest in and to the above-mentioned inventions and application for Letters Patent, and in and to any and all direct and indirect divisions, continuations and continuations-in-part of said application, and any and all Letters Patent in the United States and all foreign countries which may be granted therefore and thereon, and reissues, reexaminations and extensions of said Letters Patent, and all rights under the International Convention for the Protection of Industrial Property, the same to be held and enjoyed by Assignee, for its own use and benefit and the use and benefit of its successors, legal representatives and assigns, to the full end of the term or terms for which Letters Patent may be granted and/or extended, as fully and entirely as the same would have been held and enjoyed by Assignors, had this sale and assignment not been made.

AND for the same consideration, Assignors hereby represent and warrant to Assignee, its successors, legal representatives and assigns, that, at the time of execution and delivery of these presents, except for any rights, titles and/or interests that have arisen to Assignee under law or that have already been transferred to Assignee, Assignors are the sole and lawful owners of the entire right, title and interest in and to the said inventions and application for Letters Patent above-mentioned, and that the same are unencumbered and that Assignors have good and full right and lawful authority to sell and convey the same in the manner herein set forth.

AND for the same consideration, Assignors hereby covenant and agree to and with Assignee, its successors, legal representatives and assigns, that Assignors will sign all papers and documents, take all lawful oaths and do all acts necessary or required to be done for the procurement, maintenance, enforcement and defense of any Letters Patent and applications for Letters Patent for said inventions, whenever counsel of Assignee, or counsel of its successors, legal representatives and assigns, shall advise: that any proceeding in connection with said inventions, or said Patent application for Letters Patent, or any proceeding in connection with any Letters Patent or applications for Letters Patent for said inventions in any country, including but not limited to interference proceedings, is lawful and desirable; or, that any division, continuation or continuation-in-part of any application for Letters Patent, or any reissue, reexamination or extension of any Letters Patent, to be obtained thereon, is lawful and desirable.

AND Assignors hereby request the Commissioner of Patent and Trademarks to issue said Letters Patent of the United States to Assignee, as Assignee of said inventions and the Letters Patent to be issued thereon, for the sole use and benefit of Assignee, its successors, legal representatives and assigns.

AND Assignors hereby grant the following the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document:

S&F/WEHRW

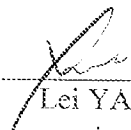
and all practitioners at Customer Number: 162494

AND Assignors acknowledge an obligation of assignment of this invention to Assignee at the time the invention was made.

Date: 4 Feb 2021


Edwin Yee Man KEH

Date: 6 Feb 2021


Lei YAO

Date: Feb 4, 2021


Hok Chung CHAN

Date: 8 Feb 2021


Sai Lung FUNG

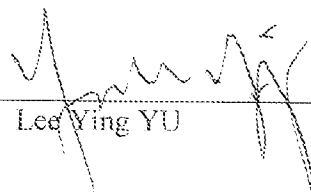
Date: 8 Feb 2021


Un Teng LAM

Date: 8 Feb 2021


Lap Hung CHAN

Date: Feb 4, 2021


Lee Ying YU